

0.65 ± 0.05 9.90 ± 0.3 1.00 ± 0.25 1.30 ± 0.15
 4.65 ± 0.25 DIM B ± 0.30 DIM A ± 0.25 3.00 ± 0.15 3.00 ± 0.15 0.15 1.40 ± 0.2
 7.46 ± 0.3 11.20 ± 0.3 15.80 ± 0.3 DIM A ± 0.05

2.90

1.27

11.56

2.90

6.93

5.60

 3.00 ± 0.05

1.73

1.57

3.40

1.65

PCB.WELDING DRAWING (TOLERANCE: ± 0.05)

技术指标:

- 1.温度范围: $-25^{\circ}\text{C} \sim 85^{\circ}\text{C}$.
- 2.额定电流: 5.0A AC DC.
- 3.额定电压: 250V AC DC.
- 4.耐电压: 1000V

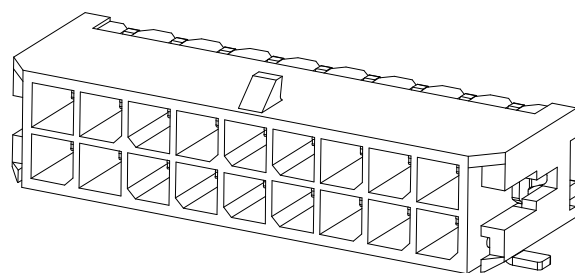
AC/minute.

- 5.接触电阻: $\leq 20\text{m}\Omega$.
- 6.绝缘电阻: $\geq 1000\text{M}\Omega$.

材质:

- 1.胶芯: LCP UL94V-0 黑色
- 2.端子: 铜合金/表面镀锡
- 3.焊片: 铜合金/表面镀锡
- 4.不锈钢吸盖: 不锈钢

型号	CKT	A	B
WAFER-MX3.0-2PWB	2*1	0.00	6.65
WAFER-MX3.0-4PWB	2*2	3.00	9.65
WAFER-MX3.0-6PWB	2*3	6.00	12.65
WAFER-MX3.0-8PWB	2*4	9.00	15.65
WAFER-MX3.0-10PWB	2*5	12.00	18.65
WAFER-MX3.0-12PWB	2*6	15.00	21.65
WAFER-MX3.0-14PWB	2*7	18.00	24.65
WAFER-MX3.0-16PWB	2*8	21.00	27.65
WAFER-MX3.0-18PWB	2*9	24.00	30.65
WAFER-MX3.0-20PWB	2*10	27.00	33.65
WAFER-MX3.0-22PWB	2*11	30.00	36.65
WAFER-MX3.0-24PWB	2*12	33.00	39.65



MANUFACTURE DWG

UNLESS OTHERWISE
SPECIFIED TOLERANCES

DECIMALS:

X.X ± 0.30 X.XX ± 0.25 X.XXX ± 0.15

ANGLES:

X. $^{\circ} \pm 5^{\circ}$ X.X $^{\circ} \pm 1^{\circ}$ 东莞市讯普电子科技有限公司
DongGuan XunPu Electronics Co.,Ltd

TITLE:

MX3.0MM 双排带扣贴片

PAR

WAFER-MX3.0-NPWB

DWN

CHKD

APVD

SCALE:A

UNIT:MM

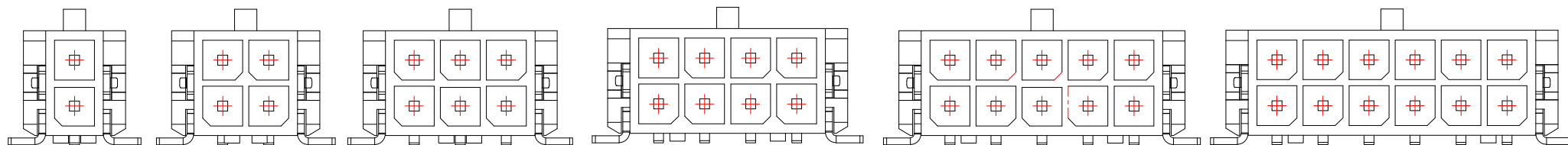
SIZE:A4

SHEET:1F1

REV:A

ROHS Compliant

MAPX	MODIFICATION	DATE	DRAW	APPROVE



2*1

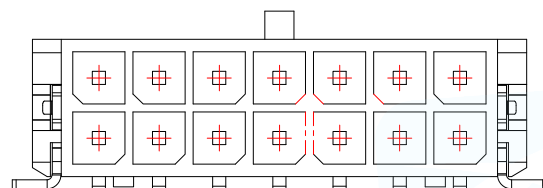
2*2

2*3

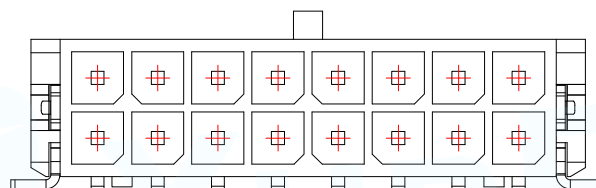
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2*5

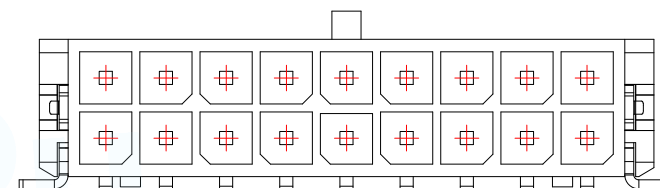
2*6



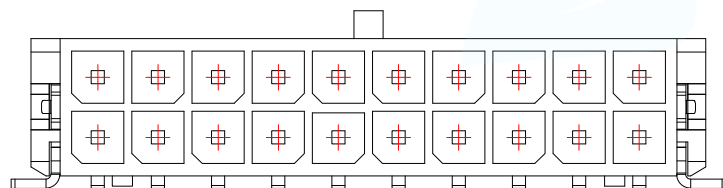
2*7



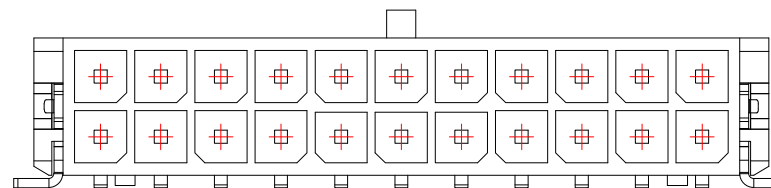
2*8



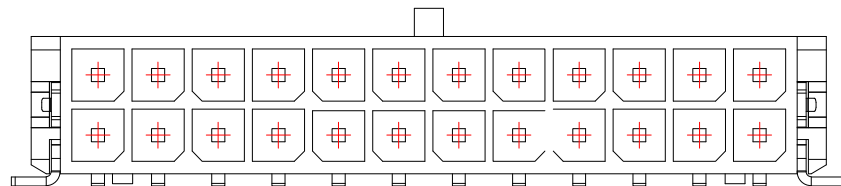
2*9



2*10



2*11



2*12

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: MX3.0MM 双排带扣卧贴
			PAR WAFER-MX3.0-NPWB
			DWN
			CHKD
DECIMALS:	ANGLES:		APVD
X.X±0.30	X.*±5°		SCALE:A
X.XX±0.25	X.X'±1°		UNIT:MM
X.XXX±0.15			SIZE:A4
CUSTOMER COPY			SHEET:1F1
			REV:A